

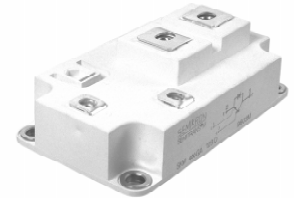
Absolute Maximum Ratings		Values	Units
Symbol	Conditions ¹⁾		
V_{CES}		1700	V
V_{CGR}	$R_{GE} = 20 \text{ k}\Omega$	1700	V
$I_C; I_{CN}$	$T_{case} = 25/75 \text{ }^\circ\text{C}$	540 / 400	A
I_{CM}	$T_{case} = 25/75 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	1080 / 800	A
V_{GES}		± 20	V
P_{tot}	per IGBT, $T_{case} = 25 \text{ }^\circ\text{C}$	2780	W
$T_j, (T_{stg})$		-40 ... +150 (125)	$^\circ\text{C}$
V_{isol}	AC, 1 min. ⁴⁾	3400	V
humidity	DIN 40 040	Class F	
climate	DIN IEC 68 T.1	40/125/56	
Inverse Diode ⁸⁾			
$I_F = -I_C$	$T_{case} = 25/75 \text{ }^\circ\text{C}$	380 / 275	A
$I_{FM} = -I_{CM}$	$T_{case} = 25/75 \text{ }^\circ\text{C}; t_p = 1 \text{ ms}$	1080 / 800	A
I_{FSM}	$t_p = 10 \text{ ms}; \text{sin.}; T_j = 150 \text{ }^\circ\text{C}$	2900	A
I^2t	$t_p = 10 \text{ ms}; T_j = 150 \text{ }^\circ\text{C}$	42000	A^2s

Characteristics		min.	typ.	max.	Units
Symbol	Conditions ¹⁾				
$V_{(BR)CES}$	$V_{GE} = 0, I_C = 6 \text{ mA}$	$\geq V_{CES}$	-	-	V
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 20 \text{ mA}$	4,8	5,5	6,2	V
I_{CES}	$V_{GE} = 0 \left. \begin{array}{l} T_j = 25 \text{ }^\circ\text{C} \\ T_j = 125 \text{ }^\circ\text{C} \end{array} \right\}$	-	0,1	0,6	mA
	$V_{CE} = V_{CES}$	-	8	-	
I_{GES}	$V_{GE} = 20 \text{ V}, V_{CE} = 0$	-	-	100	nA
V_{CESat}	$I_C = 300 \text{ A} \left. \begin{array}{l} V_{GE} = 15 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$	-	2,8(3,25)	-	V
	$I_C = 400 \text{ A}$	-	3,3(3,6)	-	V
g_{fs}	$V_{CE} = 20 \text{ V}, I_C = 300 \text{ A}$	108	150	-	S
C_{CHC}	per IGBT	-	-	1,4	nF
C_{ies}	$V_{GE} = 0$	-	22	-	nF
C_{oes}	$V_{CE} = 25 \text{ V}$	-	3	-	nF
C_{res}	$f = 1 \text{ MHz}$	-	1	-	nF
L_{CE}		-	-	20	nH
$t_{d(on)}$	$V_{CC} = 1200 \text{ V}$	-	120	-	ns
t_r	$V_{GE} = -15 \text{ V} / +15 \text{ V}^{3)}$	-	130	-	ns
$t_{d(off)}$	$I_C = 300 \text{ A}, \text{ind. load}$	-	1000	-	ns
t_f	$R_{Gon} = R_{Goff} = 5,6 \text{ } \Omega$	-	140	-	ns
E_{on}	$T_j = 125 \text{ }^\circ\text{C}$	-	220	-	mWs
E_{off}	$L_S = 60 \text{ nH}$	-	150	-	mWs
Inverse Diode ⁸⁾					
$V_F = V_{EC}$	$I_F = 300 \text{ A} \left. \begin{array}{l} V_{GE} = 0 \text{ V}; \\ T_j = 25 (125) \text{ }^\circ\text{C} \end{array} \right\}$	-	2,2(1,9)	2,7(2,4)	V
$V_F = V_{EC}$	$I_F = 400 \text{ A}$	-	2,4(2,25)	-	V
V_{TO}	$T_j = 125 \text{ }^\circ\text{C}$	-	1,3	1,5	V
r_t	$T_j = 125 \text{ }^\circ\text{C}$	-	3	3,2	$\text{m}\Omega$
I_{RRM}	$I_F = 300 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}^{2)}$	-	120(170)	-	A
Q_{rr}	$I_F = 300 \text{ A}; T_j = 25 (125) \text{ }^\circ\text{C}^{2)}$	-	30(72)	-	μC
Thermal characteristics					
R_{thjc}	per IGBT	-	-	0,045	$^\circ\text{C}/\text{W}$
R_{thjc}	per diode D	-	-	0,125	$^\circ\text{C}/\text{W}$
R_{thch}	per module	-	-	0,038	$^\circ\text{C}/\text{W}$

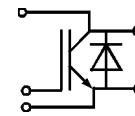
SEMITRANS® M Low Loss IGBT Modules

SKM 400 GA 174 D

Preliminary Data



SEMITRANS 4



GA

Features

- MOS input (voltage controlled)
- N channel, homogeneous Silicon structure (NPT- Non punch-through IGBT)
- Low inductance case
- Low tail current with low temperature dependence
- High short circuit capability, self limiting to $4 * I_{Cnom}$
- Latch-up free
- Fast & soft inverse CAL diodes ⁸⁾
- Isolated copper baseplate using DCB Direct Copper Bonding
- Large clearance (13 mm) and creepage distances (20 mm)

Typical Applications

- AC inverter drives on mains 575 - 750 V_{AC}
- DC bus voltage 750 - 1200 V_{DC}
- Public transport (auxiliary syst.)
- Switching (not for linear use)

¹⁾ $T_{case} = 25 \text{ }^\circ\text{C}$, unless otherwise specified

²⁾ $I_F = -I_C, V_R = 1200 \text{ V}, -di_F/dt = 1500 \text{ A}/\mu\text{s}, V_{GE} = 0 \text{ V}$

³⁾ Use $V_{GEOff} = -5 \text{ ... } -15 \text{ V}$

⁴⁾ Option $V_{isol} = 4000\text{V}/1 \text{ min}$ add suffix „H4“ - on request

⁸⁾ CAL = Controlled Axial Lifetime Technology

Cases and mech. data → B6-278

SKM 400 GA 174 D

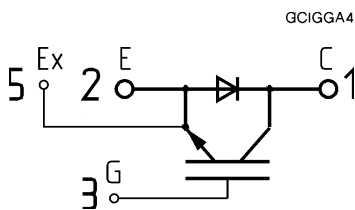
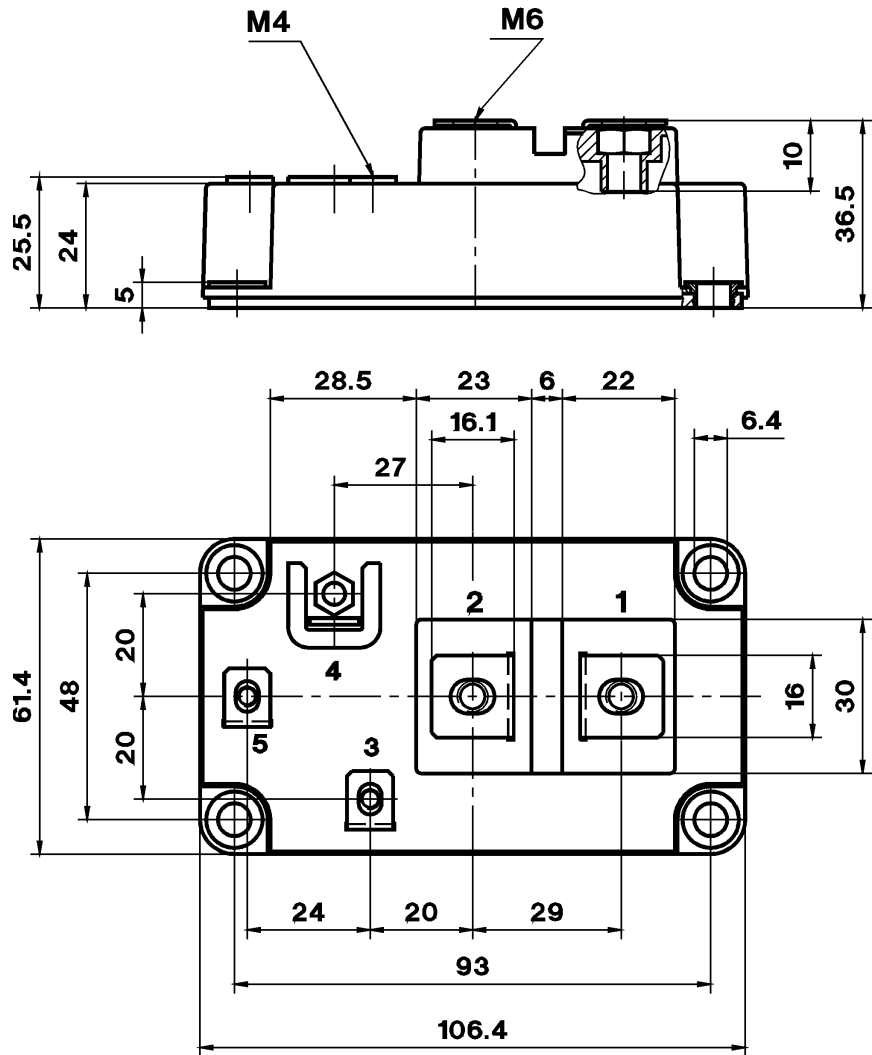
SEMITRANS 4

Case D 59

UL Recognition
File no. E 63 532
applied for

CASED59

SKM 400 GA 174 D



Dimensions in mm

Option SKM 400 GA 174 DS on request:

Terminal 4 = collector sense V_{CE} , add suffix „S“. → B 6 – 212

Case outline and circuit diagram

Mechanical Data		Values			Units
Symbol	Conditions	min.	typ.	max.	
M ₁	to heatsink, SI Units (M6)	3	–	5	Nm
	to heatsink, US Units	27	–	44	lb.in.
M ₂	for terminals, SI Units (M6/M4)	2,5/1,1	–	5/2	Nm
	for terminals, US Units	22/10	–	44/18	lb.in.
a		–	–	5x9,81	m/s ²
w		–	–	330	g

This is an electrostatic discharge sensitive device (ESDS).

Please observe the international standard IEC 747-1, Chapter IX.

Three devices are supplied in one SEMIBOX B without mounting hardware, which can be ordered separately under Ident No. 33321100 (for 10 SEMITRANS 4)

Larger packing units of 12 or 20 pieces are used if suitable
Accessories → B 6 – 4
SEMIBOX → C – 1.